11-16-1998 FORM PTO-1595 U.S. DEPARTMENT OF COMMERCE HEET 1-31-92 Patent and Tradena To the Commissioner of Patents and Tr 100877843 ginal documents or copy thereof. Name of conveying party(ies): 2. Name and address of receiving party(ies): HIROYUKI WADA, HISASHI MASUDA, KENJI KONDO, MICHIO OKA and YUUSHI KANEDA Name: Sony Corporation Internal Address: Additional name(s) of conveying party(ies) attached? Street Address: 7-35, Kitashinagawa 6-Chome Yes X City, State and Zip: Shinagawa-ku, Tokyo, JAPAN Nature of Conveyance: Additional Name(s) & address(es) attached? Assignment Merger Yes X No Security Agreement Change of Name Other Execution Date: October 29, 1998 and November 4, 1998 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: __ Patent Application No. 09/162,105 B. Patent No.(s) Filed: September 28, 1998 Additional numbers attached? Yes X No Name and address of party to whom correspondence concerning 6. Total number of applications and patents involved: 1 document should be mailed: Name: Charles P. Sammut 7. Total fee (37 CFR 3.41):.....\$ 40.00 X Enclosed Internal Address: Limbach & Limbach L.L.P. Charge any deficiencies in the enclosed fee to Street Address: 2001 Ferry Building Deposit Account No. 12-1420 City, State, ZIP: San Francisco, California 94111 Authorized to be charged to deposit account Telephone: (415) 433-4150 Facsimile: (415) 433-8716 8. Deposit account number: 12-1420 Attorney Docket No. SONY-Q8058 DO NOT USE THIS SPACE Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charles P. Sammut, Reg. No. 28,901 November 9, 1998 Name of Person Signing Total number of pages including cover sheet, attachments and document: 3Do not detach this portion 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents and Trademarks, Box Assignments, Washington, D.C. 20231

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Revised: 04/21/97

Docket Number: SONY-Q8058

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in OPTICAL SYSTEM HAVING STABLE RESONATOR

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/162,105, Filing Date: 9/28/1998.

This assignment executed on the dates indicated below.

| HIROYUKI WADA | October 29, 1998 |
|--|---|
| Name of first or sole inventor | Execution date of U.S. Patent Application |
| KANAGAWA, JAPAN | |
| Residence of first or sole inventor Wada Signature of first or sole inventor | October 29, 1998 |
| Signature of first or sole inventor | Date of this assignment |

PATENT REEL: 9572 FRAME: 0821

| HISASHI MASUDA | 10/29/98 |
|--|--|
| Name of second inventor | Execution date of U.S. Patent Application |
| TOKYO, JAPAN Residence of second inventor | |
| OSA Char | 10/29/98 |
| Signature of second inventor | Date of this assignmen |
| | |
| | |
| KENJI KONDO | October 29 1998 |
| Name of third inventor | Execution date of U.S. Patent Application |
| SAITAMA, JAPAN | |
| Residence of third inventor Kenju Konder Signature of third inventor | October 29 1998 |
| Signature of third inventor | Data of this assignment |
| MICHIO OKA | October 29 1998 |
| Name of fourth investor | Execution date of U.S. Patent Application |
| TOKYO, JAPAN | |
| Residence of fourth inventor Signature of fourth inventor | Octuber 29 1998 Date of this assignment |
| | |
| YUUSHI KANEDA | November 4 1996 |
| iems of fifth investor | Execution date of U.S. Patent Application |
| TOKYO, JAPAN | |
| Gww Fd | November 4 1882 |
| grature of futh lavestor | Date of this assignment |

PATENT REEL: 9572 FRAME: 0822

RECORDED: 11/12/1998